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CALIBRATION OF THE PIXEL DETECTOR AT CMS

THESIS

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Chapter 1

Introduction

1.1 Particle Physics and the Standard Model

Elementary particle physics is the study of the particles at the most fundamental level, the constituents of the universe as well as the interactions between them which are called, electromagnetic force, nuclear weak force and nuclear strong force and there is also the gravity force but this one doesn't have a satisfactory quantum theory for it. Each of these forces are mediated by exchange particles, in the case of the electromagnetic force the mediator is the photon, for the strong force the gluons, for the weak force the bosons W and Z and for the gravity we have the hypothetical graviton. [1]

Force	Strength	Theory	Mediator
Strong	10	Chromodynamics	Gluon
Electromagnetic	10^{-2}	Electrodynamics	Photon
Weak	10^{-13}	Flavordynamics	W and Z
Gravitational	10^{-42}	Geometrodynamics	Graviton

Fig. 1.1 Comparison of the strength magnitude of the four fundamental forces

Each of these forces have a mathematical description for the physical systems of these interactions using the Quantum Field Theory (QFT). The one that describes systems under the electromagnetic force is called Quantum Electrodynamics (QED) this force dictates the electronic structure of atoms being the low energy manifestation of the electromagnetic theory. For the strong force Quantum Chromodynamics (QCD) is the fundamental theory of strong interactions, this force is responsible of maintaining protons and neutrons together

in the atomic nucleus. For the weak interactions there is no particular name in the same way as the previous two, this force is carried by all quarks and leptons and is responsible for the β Decay of some radioactive isotopes and nuclear processes of the sun. [2]

Almost all the physical phenomena can be explained with only the electron, the electron neutrino, the proton and the neutron interacting with the electromagnetic force, the strong force and the weak one. When higher levels of energy are present new particles are observed, all of this is known as the elementary particles which are embodied in the standard model of particle physics that is by far the best theoretical model that describes interaction of this elementary particles. Is divided into two categories the bosonic sector and the fermionic sector. [2]

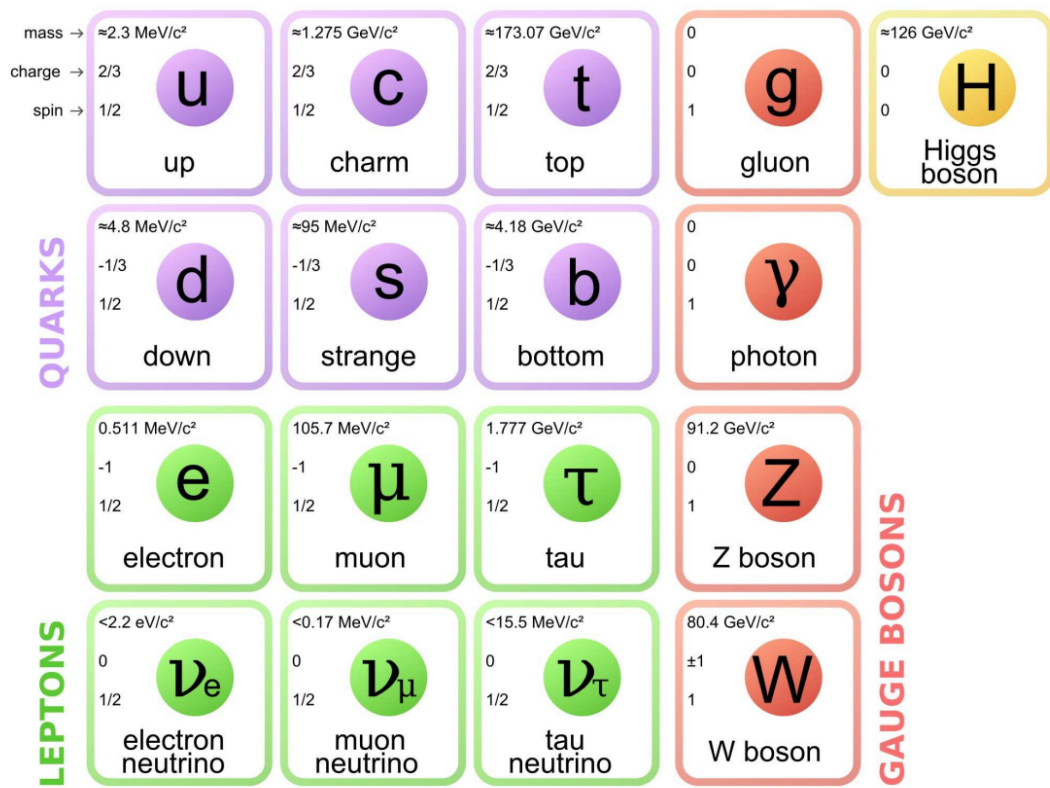


Fig. 1.2 The standard model of particle physics

The fermionic sector contains particle the particles that make up all known matter in the universe and is divided into the leptons and the quarks, both of this particles are divided into three generations, each generation being heavier than the one before. For the leptons we have electron and Its neutrino for the first generation, the second generation is. the μ and Its neutrino and the third one is the with Its neutrino. In the case of quarks we have the quark up and the quark down for the first generation, the second generation que have the quark charmd and the quark strange and for the third generation que have the quark top and the quark bottom. The bosons are the mediator particles called the gauge bosons

already mentions, the photon, the gluon, the bosons W^\pm and the boson Z . There is also the Higgs boson, which is the last gauge boson and it's the responsible to give mass to the other SM particles

One of the main sources to obtain elementary particles is particle accelerators, in this you accelerate a particle into high energy and smash them with a target, with the proper arrangements of magnets you can study the debris from the collision, for more heavy particles you need higher level of energy to the collision.

1.2 Large Hadron Collider

The Large Hadron Collider (LHC) is the biggest and powerful particle accelerator in the world at this moment, It is a 27 kilometers ring of superconducting magnets, this magnets boost the particles energies to obtain speeds that are close to the light speed before collisions. These particles are introduced as to the accelerator as particles beams this beams travel in opposing directions in tubes that are kept at ultrahigh vacuum, with the help of a electromagnetic field made by the electromagnets operating in superconduct state at low temperatures thanks to liquid helium this particles are guided across the whole accelerator. [3]

The LHC is part of an accelerator complex in CERN that is a succession of different machines that increase the energy of the beam of particles before passing into the next one on the sequence the particles at last are introduced on the LHC which is the last element in the sequence. The particles start at the linear accelerator 4 (Linac4) which is the source of the protons beams, it accelerates the particles in this case negative hydrogen ions to 160 MeV to enter the Proton Synchrotron Booster (PSB), this is where the hydrogen loses its two electrons leaving only protons and accelerating the beam to 2 GeV and then are injected into the Proton Synchrotron (PS), in where the protons are accelerated up to 26 GeV and then they are sent into the Super Proton Synchrotron (SPS) here they are accelerated up to 450 GeV and then they're finally introduced into two beams pipes on the LHC, it takes about 4 minutes and 20 seconds to fill the LHC rings reaching energies up to 6.5 TeV, there are 4 collisions points where the detectors are located Alice, Atlas, CMS and LHCb, in the collision the total energy is of 13.6 TeV. [4]

The LHC has been working since 2009 with the discovery of the Higgs Boson on 2012 and looking for new physics It has been working on different periods called Runs, Run 1 was on the period of (2009-2013), Run 2 was on (2015-2018), Run 3 is currently on going since 2022.

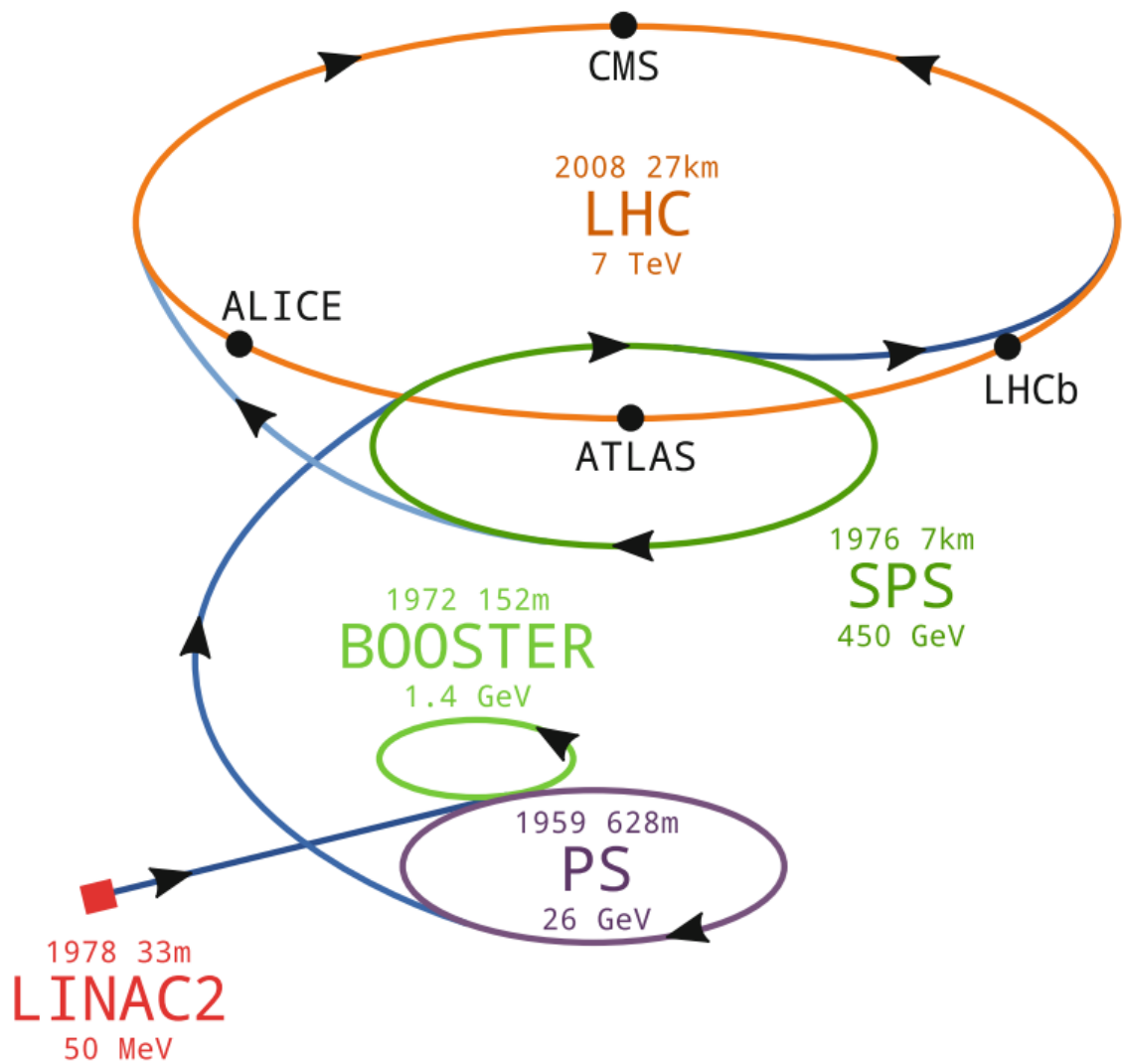


Fig. 1.3 The accelerator facility at cern for the LHC

1.3 Cross Section

The performance of a collider is determined by the beam energy and the luminosity. First we are going to define the cross section in a classical way the cross section area is parameter of interest that could say that measure the size of a target, this cross sectional area is presented to a stream of incoming particles, this is similar in the case of the scattering in elementary particles, if you fire a electron beam into a proton tank the parameters of interest are the size of the proton and the cross sectional area σ that presents the incident beam. This collision differs to the classic case in some ways, first you could call the target soft since It's not a possible collision more like the closer you get the greater the deflection, the electrons scatters off the hydrogen, various interactions are happening during this and

each one has a It's own scattering cross section σ_i nevertheless in the experiment we are interested in the total cross section which can be seen as the sum of all the cross sections.

$$\sigma_{tot} = \sum_{i=1}^n \sigma_i \quad (1.1)$$

Each of this cross sections depends typically in the velocity of the incident particle, It's expected that the cross section would be proportional to the time that the incident particle spends close to It's target which means that σ is inversely proportional to the velocity but this behavior is altered close to the region of a energy that particles involved to interact forming a short lived semi-state before breaking apart, things like this make the cross section for elementary particles different to the classic one.

To explain the cross section when a target is soft lets supposed a electron encounter a potential and scatters at the angle θ , this scatter is angle is a function of a impact parameter b the distance by which this particle would have missed the scattering center had it continued on its original trajectory. The form of $\theta(B)$ depends on the potential and the smaller the impact parameter b , larger the deflection. If the particle comes with an impact parameter between b and $b + db$ it will merge in a angle between θ and $\theta + d\theta$ and even in a more general case if it passes through a infinitesimal area $d\sigma$ it will scatter into a corresponding solid angle $d\Omega$, the larger $d\sigma$ is the larger $d\Omega$ the proportionality factor between these two is called the differential cross section D this can be illustrated in the next image:

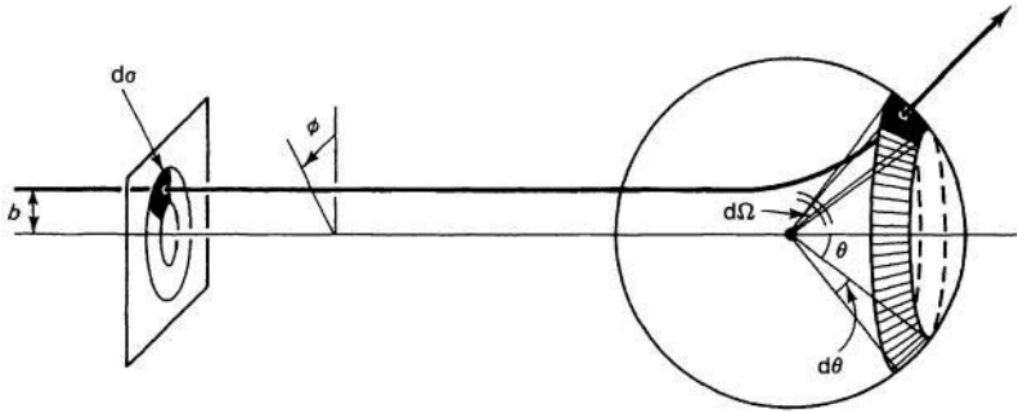


Fig. 1.4 Particle scattering

The relation between $d\sigma$ and $d\Omega$ is:

$$d\sigma = D(\theta)d\Omega \quad (1.2)$$

Supposing a beam of incoming particles with a value L that is associated with the number of particles passing down the line per unit of time and per unit of area $dN = Ld\sigma$ is the number of particles per unit time passing through area $d\sigma$ and hence also the number per unit of time scattered into solid the solid angle $d\Omega$

$$dN = Ld\sigma = LD(\theta)d\Omega \quad (1.3)$$

This could be seen as the one who controls the number of particles going through the detector also determined the solid angle.

1.4 Luminosity

The performance of a collider is determined by the beam energy and the luminosity, the luminosity is a key parameter in particle colliders is a quantity that measures the ability of a particle accelerator to produce a required number of interactions[5]

$$N = L \cdot \sigma_p \quad (1.4)$$

In which N is the number of events per second, the σ_p is the cross section and L the instantaneous luminosity. The unit of L is $cm^{-2}s^{-1}$ a higher luminosity means greater probability that the particles will collide and produce the desired interactions, luminosity can be increased then in two ways, packing more particles into the beams or focusing these beams more.

To compute the luminosity of two there are a few things that need to be taken into consideration. First the density distribution of each beam in the transverse and longitudinal plane, with the two beams moving towards each other, the position and the time as they cross each other also need to be considered and calling the distance to the collision point s_0 . The figure (1.x) shows that in principle each of the distributions is different the overlap integral can be written as follows:

In principle each of the distributions is different and we can write the overlap integral as follows:

$$2N_1N_2fN_b \int \int \int_{-\infty}^{\infty} \rho_{1x}(x)\rho_{1y}(y)\rho_{1s}(s-s_0)\rho_{2x}(x)\rho_{2y}(y)\rho_{2s}(s+s_0)dx dy ds s_0 \quad (1.5)$$

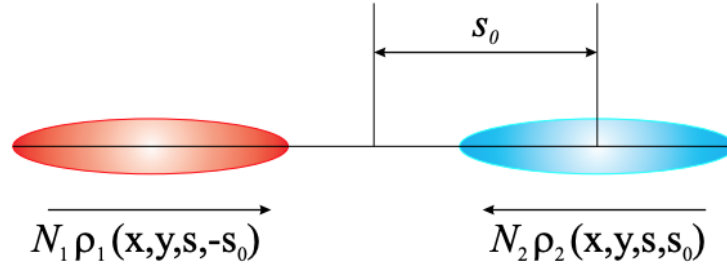


Fig. 1.5 Two beams colliding

With N_1 and N_2 being the bunch intensity, f the revolution frequency, N_b the number of colliding bunches, ρ_1 and ρ_2 time dependent beam density distribution functions, this is assuming the velocity on the beams is $v_1 = -v_2$ and the densities are uncorrelated in all planes the overlap integral takes the form of: [6]

For solving this integral one should know all distributions and an analytical solution might not be possible and numerical integration might be required.

The instantaneous luminosity is important but the final important number is called integrated luminosity. The integrated luminosity considers the total number of events during a data period is defined as:

$$L_{int} = \int L(t') dt' \quad (1.6)$$

it is related directly to the number of observed events $L_{int} \cdot \sigma_p$ number of events of interest.

In the LHC there are various ways to measure the luminosity, in the CMS there are various of them, the Pixel Luminosity Telescope, the BCM1F, the radiation monitoring system for environment safety, the muon drift tubes, the forward hadron calorimeter and the Pixel Cluster Counting (PCC).

The PCC luminometer method consists in counting the average number of pixel clusters on the detector to measure luminosity. This occurs during a zero bias event, an event that is triggered by requiring only that two proton bunches cross at the CMS interaction point. Given that the number of pixels is really big the probability that a pixel is being hit by two different tracks by the same bunch crossing is really small. The mean number of pixel clusters in a simulated zero bias event is in the order of 100 per pp collision. The number of pixel clusters per bunch crossing is linearly dependent on pileup and therefore an accurate measure of the instantaneous luminosity.[7] The mean number of pixel cluster per trigger is

$$\langle N_{cluster} \rangle = \langle N_{Pixel/Interaction} \rangle \langle N_{interaction} \rangle = \langle N_{Pixel/interaction} \rangle \mu \quad (1.7)$$

here the μ is the number of interactions and with this the following equation and gives us a relation with the cross section σ , instant luminosity and μ and for the obtention of the luminosity value:

$$\langle N_{cluster} \rangle = \frac{\sigma_{cluster}}{f} \frac{dL}{dt} \quad (1.8)$$

Here, the value of $N_{cluster}$ is the mean number of pixel clusters on the pixel detector during a zero bias trigger at a head on period, the value of $\sigma_{cluster}$ can be obtained using the Van Der Meer scan and from the equation (2.3) we can obtain the luminosity from [8]

There have been different luminosities reached on the LHC for the Run 1 a luminosity of 0.77×10^{34} was reached and a integrated luminosity of 25 fb^{-1} with a precision of 2.0% for the first part and second part of the Run 2 the luminosity measured was of 38.4 fb^{-1} with a precision of 1.3% and 78 fb^{-1} respectively[9]. The following image show shows the integrated luminosity for the CMS experiment on different years.

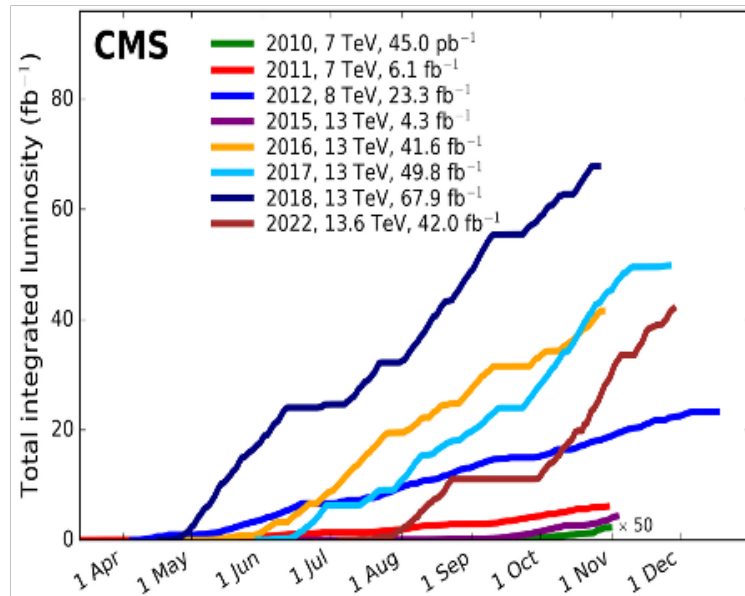


Fig. 1.6 Integrated luminosity at CMS

Chapter 2

CMS Experiment

2.1 CMS detector

The Compact Muon Solenoid (CMS) detector is one of the four interaction points on the LHC. It consists of different detectors made for different purposes, the silicon tracker, the electromagnetic calorimeter (ECAL), the hadron calorimeter (HCAL) the superconducting solenoid and the muon chamber.

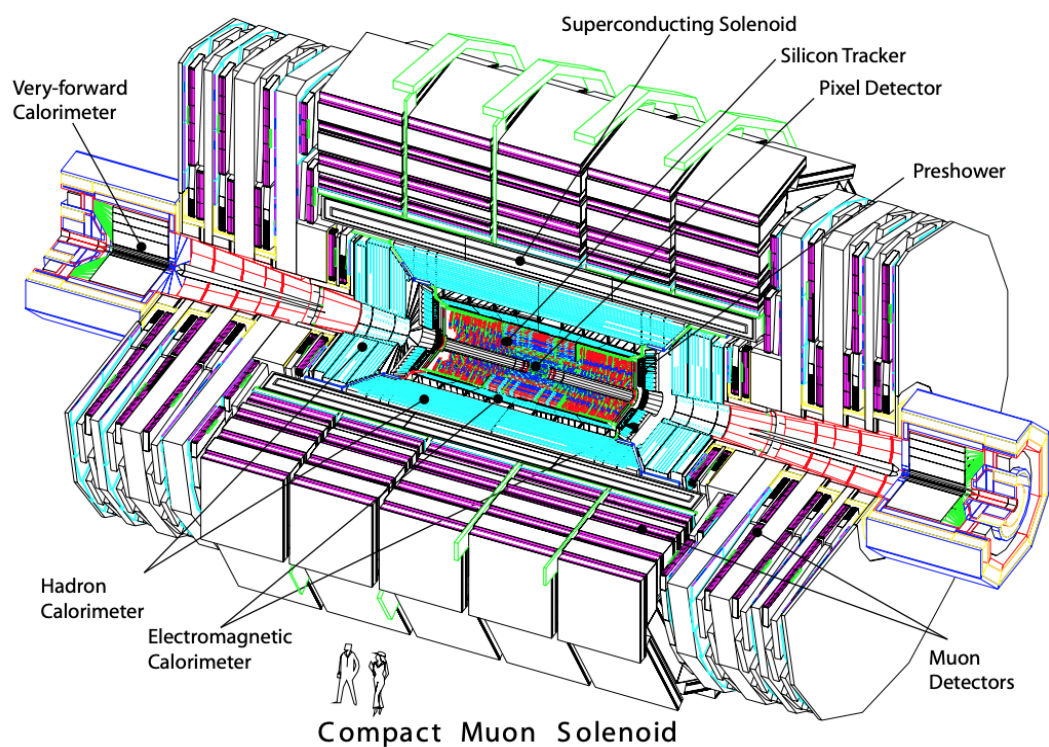


Fig. 2.1 The CMS detector size comparison with each of their components

The CMS has the form of a cylindrical onion with several concentric layers of components, these components are important to determine the properties of different particles all of this by bending their trajectories with a magnet that bends charged particles, this helps to identify the charges of the particles since they bend in different directions and allows to measure the momentum of a particle since high momentum particles bend less than the low momentum ones. The principal magnet of the CMS is called Superconducting Solenoid this magnet generates a field of about 4 Teslas and is very large 6.3m cold bore, 12.5 meters of length and 200 t of mass. The high magnetic field is confined to the volume of the detectors using the "return yoke", this yoke has a magnetic field strength of 2 Teslas and acts as the main support as well as the muon filter. It is made of a high amount of steel and it weighs more than 11000 tonnes. [10]

One of the principal objectives of the CMS is to identify with very high precision the paths taken by the particles that were bent by the magnetic field they called this part the inner tracker which is composed of different substructures, closest to the interaction point we have the Silicon Pixel Detector which will be detailed more on a later section.

Apart from the pixel detector the inner track is composed of strip detectors which are divided into the inner barrel (TIB) part and the outer barrel part (TOB), as well as the inner disks (TID) and the outer end caps (TEC). The TIB and TOB are made of four and six concentric layers barrel shell structures respectively, the TID system is made of three disk structures each divided in three concentric rings and the TEC is made of nine disk structures on each side each of these made of four to seven rings as we can see on the figure 2.2. The tracker is composed of 15,148 modules distributed among the TIB, TOB, TID and TEC each module has one or two silicon sensors for a total of 24,244 sensors. When a charged particle passes through this layer it interacts electromagnetically with the sensors leaving a hit that can be used to identify the path that a particle took. [11]

Having information of the energy is important to understand what is happening at the collision point for this purpose there are two calorimeters on the CMS. The ECAL is made of 61200 lead tungstate crystals in the central barrel cap closed by 7324 crystals in the two of the endcaps in front of these crystals there is a preshower detector, the high density crystals allow the calorimeter to be fast, have a fine granularity and being radiation resistant, its capabilities are improved by the good crystal resolution which are provided by a homogeneous crystal calorimeter. It is surrounding the tracker and aims to measure the energy of electrons, positrons or photons and stop them completely. The other calorimeter is the HCAL which is surrounding the ECAL and plays an essential role on the measurements of the energy of hadrons like the quarks, gluons, neutrinos and some exotic particles. which are also stopped here.

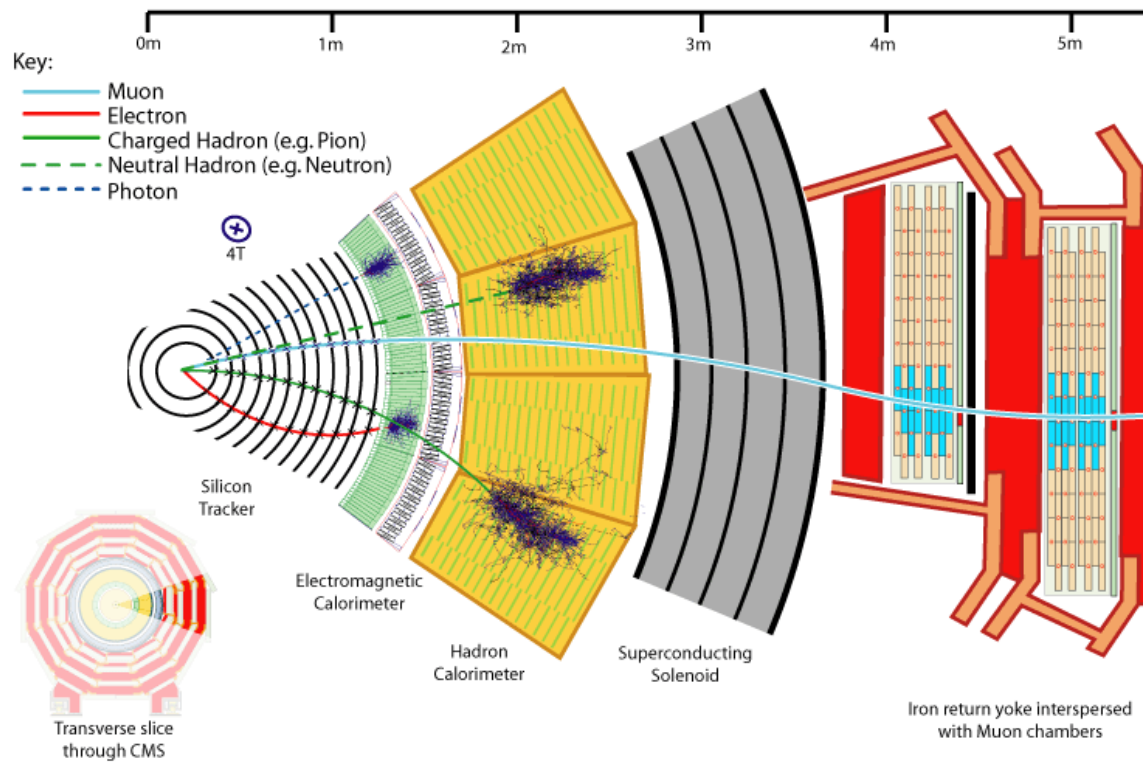


Fig. 2.2 Different particles travelling across the different detectors of the CMS experiment

The CMS was optimized for the detections of muons and is the last particle that the CMS observe directly with the help of the muon chambers that is composed by many subdetectors which are interleaved with the return of the yoke of the solenoid located after the super conducting solenoid, muons are similar to electrons but 200 times heavier so they are not stopped by the calorimeters, the muon chambers have 3 main purposes; muon identification, momentum measurement and triggering. [12]

2.2 Pixel Detector

In the innermost part part of the CMS experiment there is a silicon pixel detector which is part of the tracking system. It has the task of provide high resolution 3D space points close to the collision point for track patter recognition and vertex reconstruction. It is located in a place where there is a harsh radiation environment giving Its high track density, in the CMS there was an pixel detector that was later changed during the first long shut down of the LHC during LS1 (2013-2014) and replaced by the CMS Phase-1 Pixel Detector in order to maintain efficient and robust tracking giving that with the upgrade of the accelerators the luminosity have doubled compared to the design value. It is expected that this detector to

deliver high quality data until the end of the LHC Run 3 (Currently in process) after which the whole track detector on the CMS will be replaced.

Overall, is the closest detector to the beam pipe with cylindrical layers in the range of 3cm and 16cm at either end so It's vital to reconstruct the tracks of particles with very short live spans. It contains 124 millions pixels that allows to the tracking of the particles emerging from the collision with a extreme accuracy. It has 4 layers, each one of these layers is composed of silicon modules that are splitted into tiny silicon sensors this is what is called the pixels. These pixels have a size of $100\ \mu m - 150\ \mu m$, when a charged particle pass through this pixels it gives the electrons on the silicon enough energy to be ejected with an applied voltage these charges are collected as a small signal which is amplified by an electronic readout ship. With these signals we can know which pixels were touched, allowing us to recreate the track using the 2D tiles detectors and with the help of Its 4 layers can also generate a 3D picture. Nevertheless, the rate of the particles passing through this detectors is big at 3cm to the beam pipe the rate is about 600 million of particles $^2/s$ the pixel detector is able to reconstruct all the tracks the particles leave behind. Each of the 124 million pixels are kept to a minimum power, even with only 50 microwatts per pixel the total power output of the whole detector is it about 7.5kW. It also has a freezing system of cooling tubes and kept about 20 degrees celsius reducing the damage to the modules made by the large stream of particles.

The layout of the detector is optimized to have four hit coverage over the pseudorapidity range of $|\eta| < 2.5$ which is important to improve the pattern recognition and track reconstruction and added redundancy to cope with hit loses. Apart from this the detector consist in the already mentioned four concentric barrel layers (L1-L4) with specific radius of 29mm, 68mm, 109 mm and 160 mm and three disks (D1-D3) on the ends with distances to the center of 291mm, 396mm and 516mm and the total silicon area is of $1.9\ m^2$. The detector is built from 1856 silicon sensor modules, 1184 of these are on the barrel pixel detectors (BPIX) and the rest one are on the forward pixel detectors (FPIX), each module consist in a sensor of 160x416 pixels connected to 16 readout chips (ROCs) for a total of 124 millions readout channels. [13]

The BPIX and FPIX detectors are independent components, the BPIX consist in two half barrels with a length of 540mm each of the four layers are called half shells and is divided into two mechanically independent halves both composed of one half detector and two service half-cylinders. The FPIX is assembled from twelve disks which are divided into inner and outer half rings which supports 22 and 34 modules respectively and is divided into four mechanically independent quadrants each formed by three half-disks installed in a service half cylinder. This detectors are supplied with four service half-cylinders that hold the readout and control circuits.

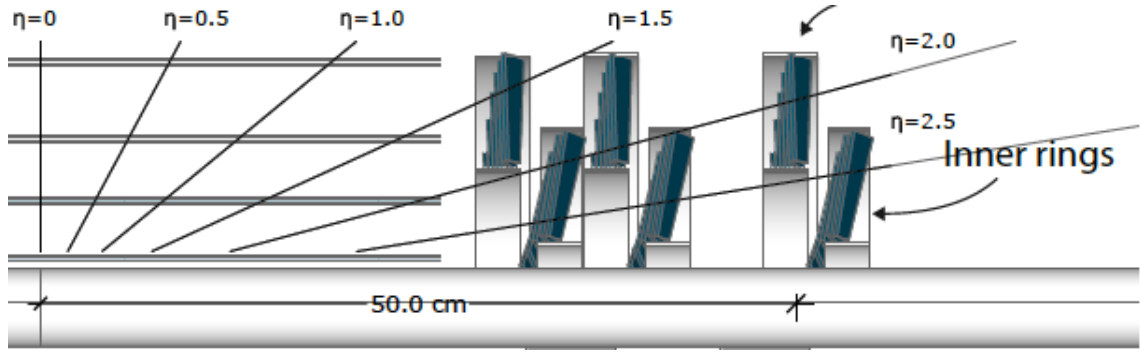


Fig. 2.3 Pixel detector outer rings and inner rings structure

In order to optimize the resolution of the tracking and the vertexing the materials used in the detector were minimized. Even with the additional layers the material budget for the CMS Phase-1 Pixel in the central region is almost the same as the original detector while reducing the forward region. This is possible thanks to the advanced nano carbon-fiber materials for the mechanical structure that adopt the usage of lower mass, and two phases CO_2 cooling systems. The electronics boards on the service half-cylinders are placed in higher pseudorapidity regions outside of the tracking acceptance.

The innermost layer have to support high levels of radiation and hit rates a hadron fluence of $3.6 \times 10^{15} n_{eq}/cm^2$ (n_{eq} is the units of 1 MeV of neutrons equivalent) is expected in the innermost layer after collecting a integrated luminosity of $500 fb^{-1}$. In the outer layers of the BPIX and on the FPIX the expected hit rates are of about $600 MHz/cm^2$ for BPIX L1.

The silicon detector modules is built from a planar silicon sensor bonded to an array of 2×8 ROCs. Each ROC is segmented on 4160 readout channels and reads information about each pixel. Since 2 ROCs can only be placed at a minimum distance between each other pixels along the ROC boundaries have twice the area and those at the corners have four times the area of a pixel, in the other side of the silicon sensor there is a high density interconnect (HDI). To simplify the module production as well Its maintenance, the same rectangular module geometry is used for both BPIX and FPIX detectors. In the BPIX detector the orientation of the sensor surface is parallel to the magnetic field, this means that the pixels are oriented parallel to the beam line. The FPIX detectors in the outer rings are rotated 20 degrees, in the inner ring the modules are arranged in an inverted cone array with an angle of 12 degrees respect to the beam line combined with the 20 degrees rotation. The orientation for the FPIX is made such as the long side of the pixels is in the radial direction.

The sensors of BPIX and FPIX were designed by two different companies, BPIX was made by CiS Forschungsinstitut für Mikrosensorik in efurt on germany and FPIX was made on SINTEF micro-systems and sensors in Norway. The BPIX sensors were made on

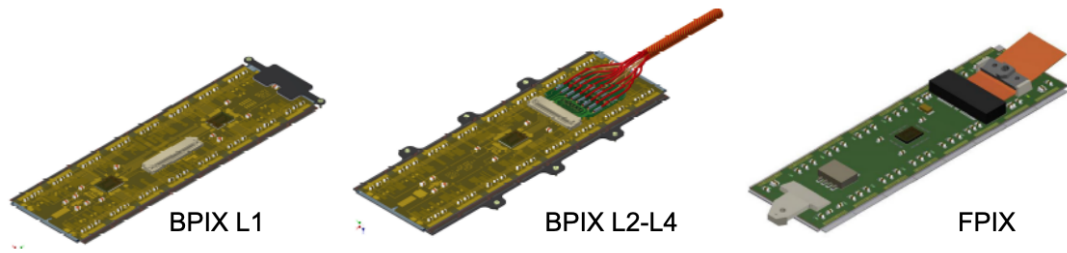
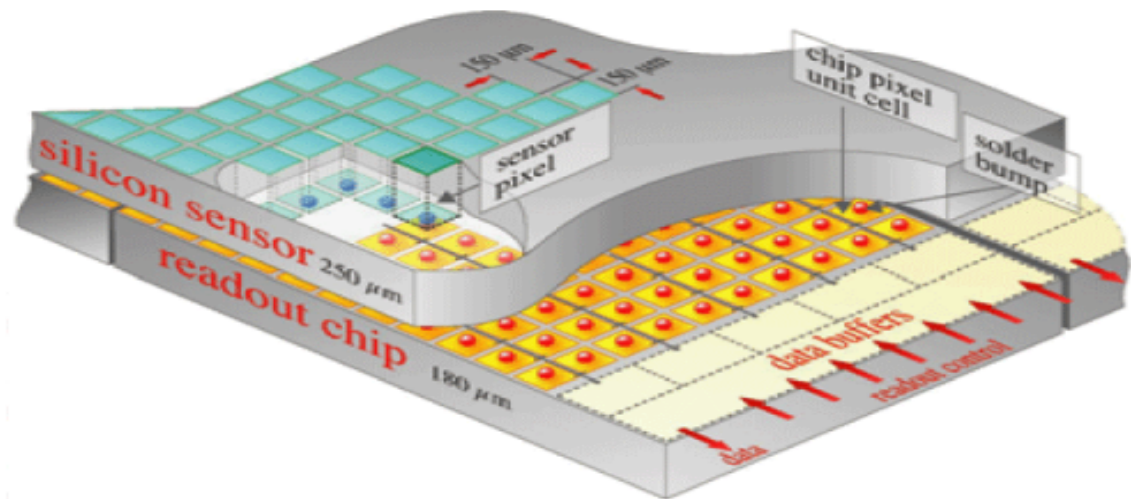


Fig. 2.4 Barrel Pixel Detector modules and Forward Pixel Detector Modules

approximately $285\ \mu\text{m}$ of phosphorous-dope 4-inch wafers from silicon mono-crystals, all of these sensors were produced using silicon from the same ingot. In the other side, the FPIX sensors were made on $300\ \mu\text{m}$ thick 6 inch float-zone wafers, eight sensors were placed on one wafer, the wafers were accepted if at least six of its sensors fulfill their specifications.

The readout chips are made using $250\ \text{nm}$ CMOS technology, these are named PSI46dig and PROC600. The PSI46dig is used on the outer BPIX layers (L2-L4) and in the FPIX detectors, meanwhile the PROC600 was designed for the innermost layer, taking into consideration the expected high hit rates. The single pixel efficiency of the PSI46dig at high rates was measured using internal calibration signal while exposing the ROCS to high-rate X-rays, the data losses for both of the detectors were of less than 2% at the expected maximum hit rate of $120\ \text{MHz}/\text{cm}^2$ and the PROC600 efficiency is above 95% at rates up to $600\ \text{MHz}/\text{cm}^2$.



CMS silicon pixel detector

Fig. 2.5 The pixel detector silicon sensor and the readout chip.

2.3 Cluster Identification

In the pixel detector the charged produce by charged particles passing through the silicon layers, this charge is collected by the read-out chips. This charge in general is shared between more than one pixel forming a pixel cluster, this clusters can be made by either the particle track which have a small angle of incidence with the silicon sensor or because of the charge drifting in the magnetic field of 4 Tesla in which the tracking system is immersed. Before the process of irradiation the charge sharing is uniform in local X and Y directions, even then, the reconstructions of the true hits It's not trivial. After the detector is irradiated, the defects developed in the silicon lattice act as charges traps so that the free charge can only partially reach the readout chips, consequently the pixel clusters become smaller [14]

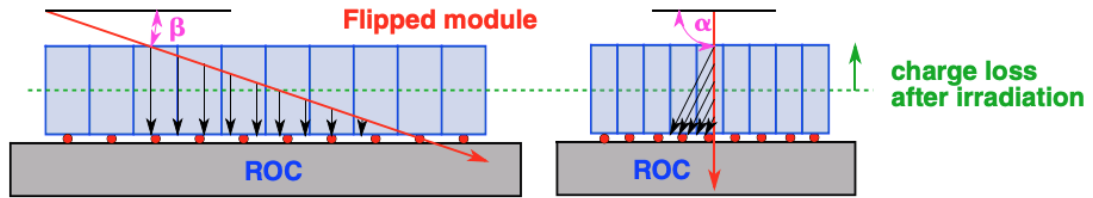


Fig. 2.6 Cluster

The first step to the reconstruction process is referred to as local reconstruction. It consist of the clustering of zero-suppressed signals above specific thresholds in pixel and strip channels into hits, and then estimating the cluster positions and their uncertainties defined in a local orthogonal coordinate system (u, v) in the plane of each sensor. [15]

2.4 Pixel Detector Module Selection

To be applicable to a van der mer scan the cluster cross section must use exactly the same detector configuration during the whole of the data taking and the calibration scan. This means if any of the modules of the detector didn't work at any point of the scans and didn't gave any readout It must be excluded from the calibration and the luminosity analysis so only a specific number of modules is selected during this. After this we obtain the stability of the modules that can be determined by a ratio of module PCC and total PCC. [16]

A module veto list is created that removes modules that have unstable behavior in the cluster counting, to the determine the number of modules excluded the stability of their contribution to the total (the module weight) is studied. This selection is made using the zero bias datasets using two steps, first a selection on the stability over time and then a selection of stability vs instantaneous luminosity. For the stability selection different

datasets are used, depending on the dataset you obtain time profiles per module and the absolute value of the deviation from the mean weight and averaged, this process is iterate for every module to remove outlier modules. For the linearity selection the module weight is evaluated as a function of quantity which is proportional to the instantaneous luminosity this quantity being the average PCC per module, the image (2.6) shows the difference between a good module and a bad module.

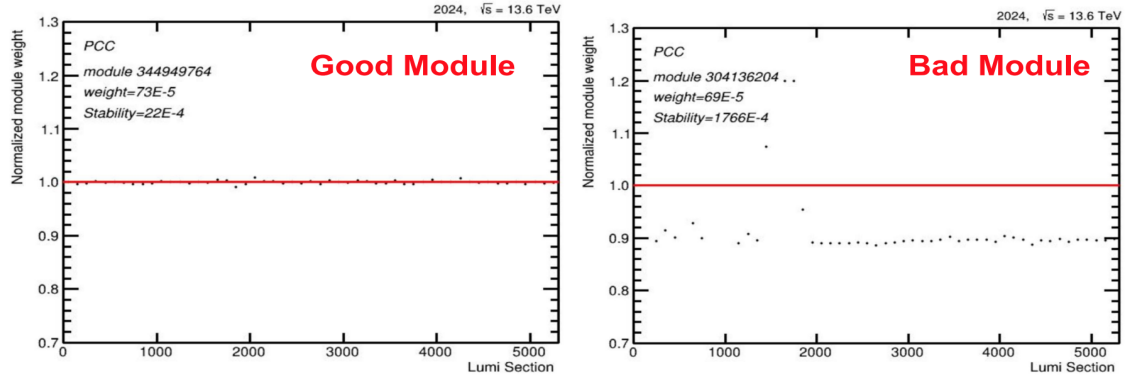


Fig. 2.7 Comparison between two modules with average PCC in 100 LS. Good module on the left, bad module on the right.

To obtain the number of modules that are damaged and can exhibit issues with stability and linearity and can affect the final luminosity measurements the following steps were followed:

- First, all of the BPIX Layer 0 Modules are removed since they are consistently unstable.
- Then modules based on the noise level are removed in the vdm fill super separation data.
- Remove modules with no clusters in the vdm fill this means with weight=0
- Compare stability parameters between modules and remove outliers in the vdm fill
- Compare stability parameter for each block of data and perform a second iteration if necessary
- Compare linearity parameter between modules and remove outliers

The pixel detector has a total of 1856 modules (1184 on the BPIX and 672 on FPIX) in this analysis for the pcc vdm calibration on 2024 for the fill 9639, a total of 1616 modules were removed for a total of 240 modules with 193 in the BPIX part of the detector and the other ones on the FPIX part.

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